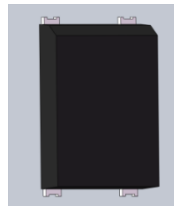


**2.5A SURFACE MOUNT FAST GLASS PASSIVATED BRIDGE RECTIFIER**
**NEW PRODUCT**
**Product Summary** (@ $T_A = +25^\circ\text{C}$ )

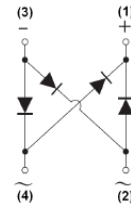
$V_{RRM}$ (V)	$I_O$ (A)	$V_{FM}$ (V)	$I_R$ ( $\mu\text{A}$ )
1000,800,600, 400,200,100	2.5	1.3	5

**Description and Applications**

Suitable for AC to DC bridge full wave rectification for SMPS, LED lighting, adapter, battery charger, home appliances, office equipment, and telecommunication applications.



Top View



Internal Schematic

**Features and Benefits**

- Glass Passivated Die Construction
- Miniature Package Saves Space on PC Boards
- Fast Recovery Time for Higher Efficiency
- Low Leakage Current
- Ideal for SMT Manufacturing
- Low Forward Voltage Drop
- Surge Overload Rating to 75A Peak
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

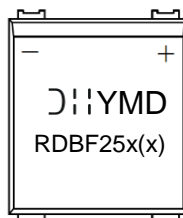
**Mechanical Data**

- Case: DBF
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 **(e3)**
- Polarity: As Marked on Body
- Weight: 0.02 grams (Approximate)

**Ordering Information** (Note 4)

Part Number	Compliance	Case	Packaging
RDBF2510-13	Commercial	DBF	3,000/Tape & Reel
RDBF258-13	Commercial	DBF	3,000/Tape & Reel
RDBF256-13	Commercial	DBF	3,000/Tape & Reel
RDBF254-13	Commercial	DBF	3,000/Tape & Reel
RDBF252-13	Commercial	DBF	3,000/Tape & Reel
RDBF251-13	Commercial	DBF	3,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

**Marking Information**


RDBF25x(x) = Product Type Marking Code  
 J||YMD = Manufacturers' Code Marking  
 YMD = Date Code Marking  
 Y = Last Digit of Year (ex: 8 = 2018)  
 M = See Month/Code Table Below  
 D = Day 1 to 9 = 1 to 9; Day 10 to 31 = A to V

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings and Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

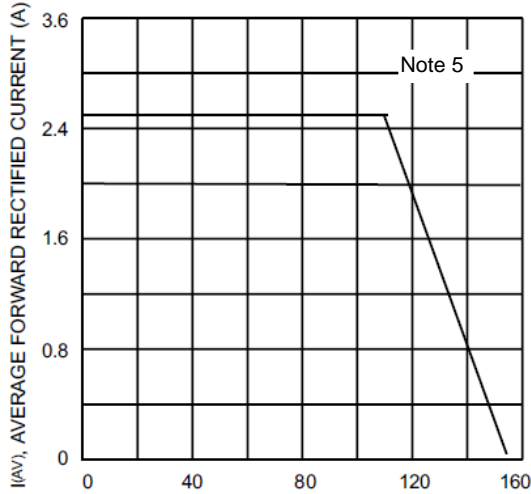
Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	RDBF251	RDBF252	RDBF254	RDBF256	RDBF258	RDBF2510	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	200	400	600	800	1000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	70	140	280	420	560	700	V
Average Rectified Output Current (Note 5) @ T <sub>C</sub> = +110°C	I <sub>O</sub>	2.5						A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	75						A
I <sup>2</sup> t Rating for Fusing (1ms < t < 8.3ms)	I <sup>2</sup> t	23.34						A <sup>2</sup> S
Max Forward Voltage (Per Element) @ I <sub>F</sub> =2.5A	V <sub>FM</sub>	1.3						V
Maximum Reverse Recovery Time (Note 7)	t <sub>RR</sub>	150			250	500		ns
Peak Reverse Current @T <sub>A</sub> =+25°C At Rated DC Blocking Voltage @T <sub>A</sub> =+125°C (Note 8)	I <sub>R</sub>				5.0 500			μA
Total Capacitance (Per Element) (Note 9)	C <sub>T</sub>	30						pF

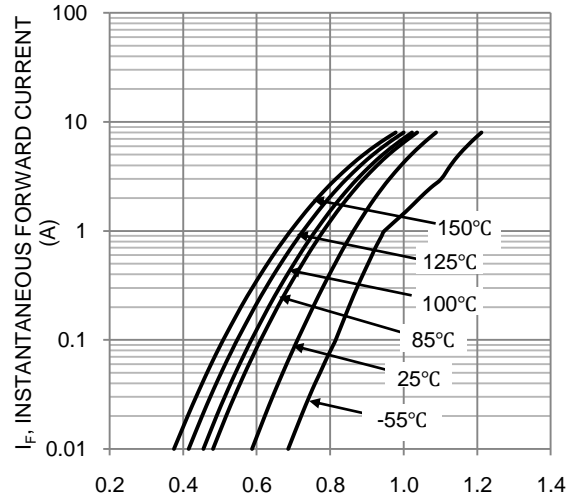
**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6) (Per Element)	R <sub>θJA</sub>	35	°C/W
Typical Thermal Resistance, Junction to Case (Per Element)	R <sub>θJC</sub>	7.8	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
- Device mounted on glass epoxy PC board with 1.3mm<sup>2</sup> solder pad.
  - Device mounted on glass epoxy substrate with 1oz/ft<sup>2</sup>, 30mmx30mm copper pad per pin.
  - Measured with I<sub>F</sub> = 0.5A, I<sub>R</sub> = 1.0A, I<sub>RR</sub> = 0.25A.
  - Short duration pulse test used to minimize self-heating effect.
  - Measured with V<sub>R</sub> = 4.0VDC, f = 1MHz



$T_C$ , CASE TEMPERATURE ( $^{\circ}C$ )  
Fig. 1 Output Current Derating Curve



$V_F$ , INSTANTANEOUS FORWARD VOLTAGE (V)  
Fig. 2 Typical Forward Characteristics (Per Leg)

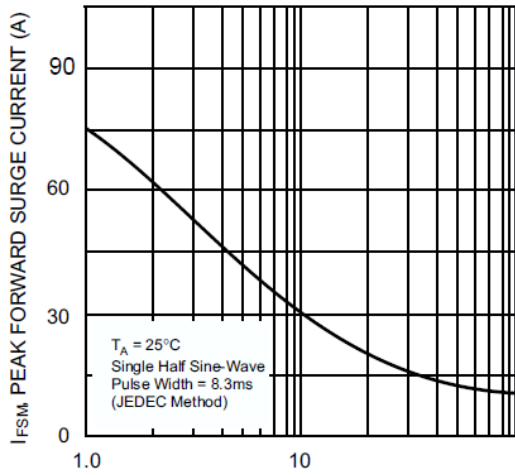


Fig. 3 Maximum Peak Forward Surge Current (per leg)

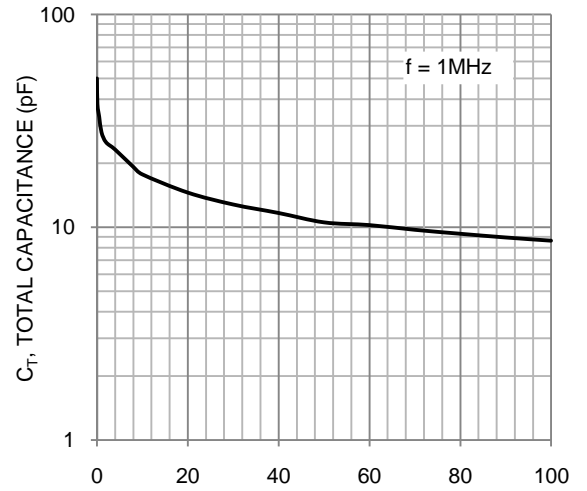


Fig. 4 Typical Junction Capacitance

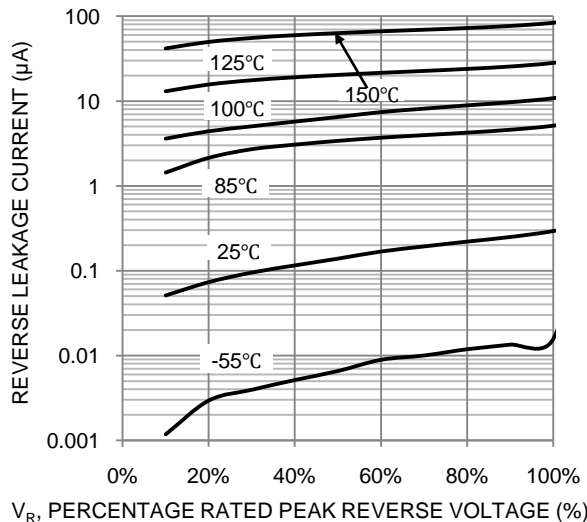


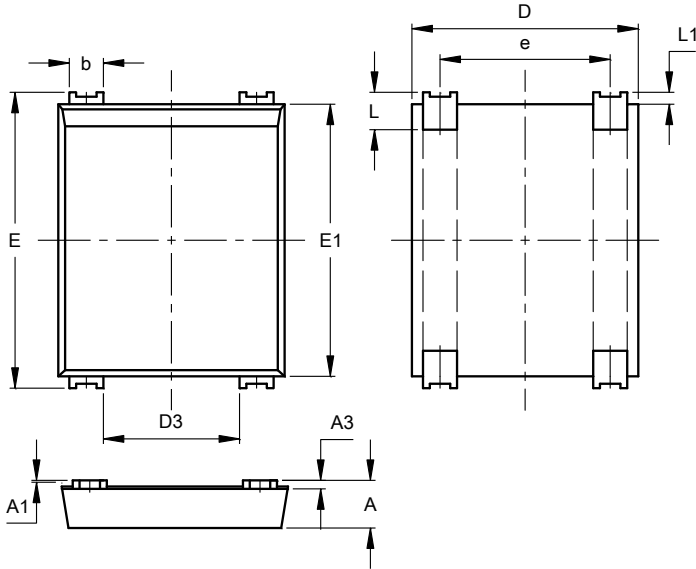
Fig.5 Typical Reverse Characteristics

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

NEW PRODUCT

DBF

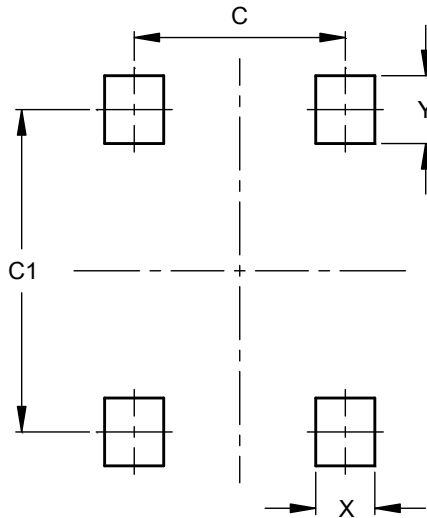


DBF			
Dim	Min	Max	Typ
A	1.30	1.50	--
A1	0.04	0.12	--
A3	0.15	0.35	--
b	0.80	1.20	--
D	6.45	6.85	--
D3	3.80	4.20	--
E	8.50	8.90	--
E1	7.80	8.20	--
e	4.80	5.20	--
L	0.80	1.40	--
L1	0.30	0.40	--
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

DBF



Dimensions	Value (in mm)
C	5.00
C1	7.60
X	1.40
Y	1.60